

C0402C202J8TACTU

Aliases (C0402C202J8TAC7867) SMD Comm X8G HT150C, Ceramic, 2,000 pF, 5%, 10 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0402, 0.3 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	1.06 mg
Shelf Life	78 Weeks
MSL	1

	Specifications	
	Capacitance	2,000 pF
	Measurement Condition	1 kHz 1.0Vrms
	Tolerance	5%
	Voltage DC	10 VDC
	Dielectric Withstanding Voltage	25 VDC
	Temperature Range	-55/+150°C
1	Temp. Coefficient	X8G
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
	Dissipation Factor	0.1% 1 kHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
	Insulation Resistance	100 GOhms

 Dimensions

 Chip Size
 0402

 L
 1mm +/-0.05mm

 W
 0.5mm +/-0.05mm

 T
 0.5mm +/-0.05mm

 S
 0.3mm MIN

 B
 0.3mm +/-0.1mm

Packaging Specifications

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	10000

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